

3rd Huixian International Forum on Earthquake Engineering for Young Researchers



August 11-12, 2017

University of Illinois at Urbana-Champaign



CEE
ILLINOIS

ANNOUNCEMENT

BACKGROUND:

The Huixian International Forum on Earthquake Engineering for Young Researchers was proposed jointly by the Huixian Earthquake Engineering Foundation and the US-China Earthquake Engineering Foundation, aiming at commemorating the pioneers in earthquake engineering and providing young researchers a platform for communication, knowledge sharing, and research collaboration. The first forum was held at the Institute of Engineering Mechanics, CEA, Harbin, China (2014), and the second forum was held at the Beijing University of Technology, Beijing, China (2016).

THEMES:

- Observation and monitoring of strong ground motions
- Ground response analysis
- Seismic slope stability and liquefaction mitigation
- Safety assessment of foundations
- Seismic analysis methods and experimental techniques
- Vibration monitoring and control
- Seismic rehabilitation techniques
- Seismic risk analysis and structural safety assessment
- Seismic safety assessment of lifeline systems
- Theories and methods of structural seismic design
- Urban seismic disaster simulation, mitigation and emergency management

Important Dates

Deadline for Abstract Submission: March 31, 2017

Acceptance Notification: April 15 2017

Deadline for 4-Page Paper Submission: June 30, 2017

Deadline for Early Registration: June 30, 2017

Registration Fee

Early Registration (June 30, 2017)

Regular: \$325; Student: \$125

On-Site Registration

Regular: \$400; Student: \$175

Venue

The Forum will be hosted by the Department of Civil and Environmental Engineering at the University of Illinois at Urbana-Champaign, Urbana, Illinois.

Conference Co-Chairs

Dr. Billie Spencer: bfs@illinois.edu

Dr. Tao Wang: wangtao@iem.ac.cn

Dr. Larry Fahnestock: fhnstck@illinois.edu

For More Information

Contact: 3hifee@gmail.com

Website: <http://sstf.cee.illinois.edu/3hifee/>